

STGW50HF60S

60 A, 600 V, very low drop IGBT

Features

- Very low on-state voltage drop
- Low switching off
- High current capability

Applications

- PV inverter
- UPS

Description

STGW50HF60S is a very low drop IGBT based on new advanced planar technology, showing extremely low on-state voltage and limited turn-off losses. The overall performance makes this IGBT ideal in low frequency switches of mixed frequency topologies for $PF \le 1$.

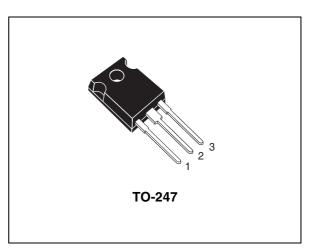


Figure 1. Internal schematic diagram

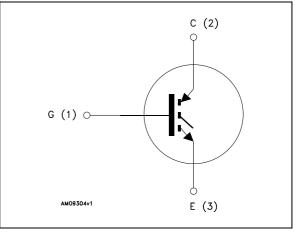


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW50HF60S	STGW50HF60S GW50HF60S		Tube

1 Electrical ratings

Table 2.	Absolute	maximum	ratings
Table 2.	Absolute	maximum	raunys

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Continuous collector current at T _C = 25 °C	110	Α
I _C ⁽¹⁾	Continuous collector current at T _C = 100 °C	60	Α
I _{CL} ⁽²⁾	Turn-off latching current	60	Α
I _{CP} ⁽³⁾	Pulsed collector current	130	Α
V _{GE}	Gate-emitter voltage	±20	V
P _{TOT}	Total dissipation at $T_{C} = 25 \ ^{\circ}C$	284	W
Тj	Operating junction temperature	- 55 to 150	°C

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Vclamp = 80% of V_{CES}, T_j =150 °C, R_G=10 $\Omega,$ V_GE=15 V
- 3. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3.Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case	0.44	°C/W
R _{thJA}	Thermal resistance junction-ambient	50	°C/W



2 Electrical characteristics

Table 4.	Static					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			v
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 30 A V _{GE} = 15 V, I _C = 30 A, T _J =125 °C		1.15 1.05	1.45	v v
V _{GE(th)}	Gate threshold voltage	V _{CE} = V _{GE} , I _C = 250 μA	3.5		5.7	V
I _{CES}	Collector cut-off current $(V_{GE} = 0)$	V _{CE} =600 V V _{CE} =600 V, T _J =125 °C			50 500	μΑ μΑ
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} =± 20 V			± 100	nA
9fs	Forward transconductance	V _{CE} = 15 V _, I _C = 30 A		25		S

Table 4. Static

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} =0	-	4300 400 100	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V _{CE} = 480 V, I _C = 30 A,V _{GE} =15 V	-	200 27 90	-	nC nC nC



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 400 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ (see Figure 14)	-	50 20 1280	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 400 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_J = 125 \text{ °C} (see Figure 14)$	-	47 22 1100	-	ns ns A/µs
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 400 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ (see Figure 14)	-	370 220 465	-	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time		-	700 250 800	-	ns ns ns

Table 6. Switching on/off (inductive load)

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon ⁽¹⁾	Turn-on switching losses	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 30 \text{ A}$		0.25		mJ
E _{off} ⁽²⁾	Turn-off switching losses	R _G = 10 Ω, V _{GE} = 15 V,	-	4.2	-	mJ
E _{ts}	Total switching losses	(see Figure 14)		4.45		mJ
Eon ⁽¹⁾	Turn-on switching losses	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 30 \text{ A}$		0.45		mJ
E _{off} ⁽²⁾	Turn-off switching losses	R _G = 10 Ω, V _{GE} = 15 V,	-	7.8	-	mJ
E _{ts}	Total switching losses	T _J = 125 °C <i>(see Figure 14)</i>		8.25		mJ

 Eon is the turn-on losses when a typical diode is used in the test circuit in *Figure 14*. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at the same temperature (25 °C and 125 °C).

2. Turn-off losses include also the tail of the collector current.



VCE(sat)

(V)

1.5

1.4

1.3

1.2

1.1

1.0

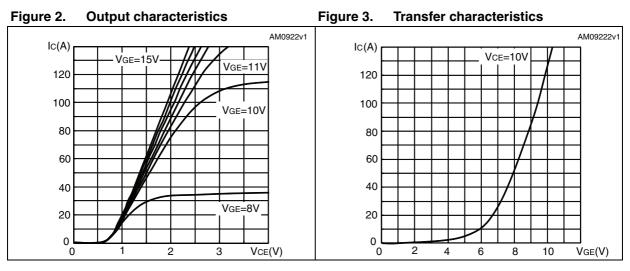
0.9

0.8

57

-50

2.1 Electrical characteristics (curves)



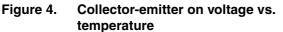
AM08877v1

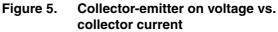
I_C=60A

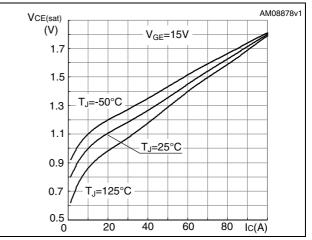
I_C=30A

I_C=15A

TJ(°C)







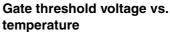


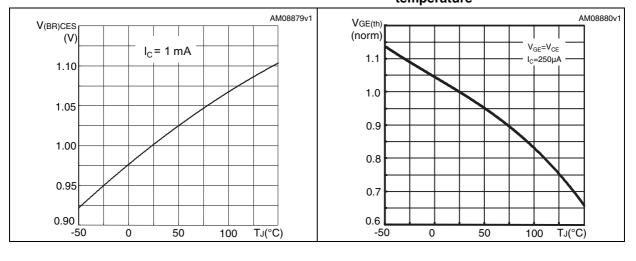
50

0

100

V_{GE}=15V





Doc ID 16989 Rev 2

Vge

(V)

16

12

8

4

0

0

Figure 8. Gate charge vs. gate-emitter voltage

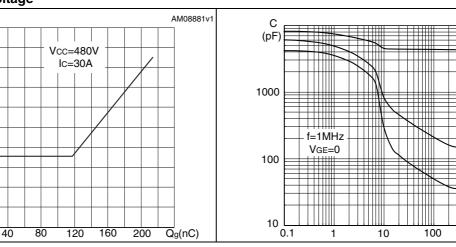
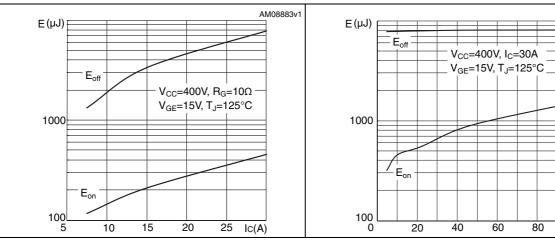
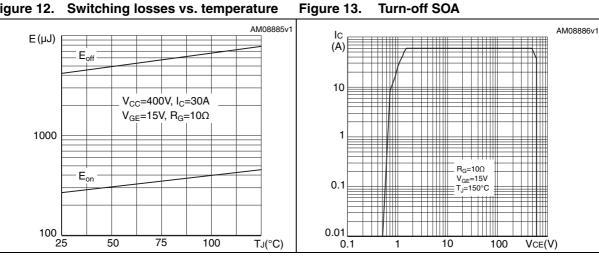


Figure 9.

Figure 10. Switching losses vs. collector current







1

Figure 11. Switching losses vs. gate

resistance

10

100

Capacitance variations

STGW50HF60S

AM08882v1

Cies

Coes

Cres

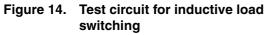
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 $R_G(\Omega)$

VCE(V)



3 Test circuits



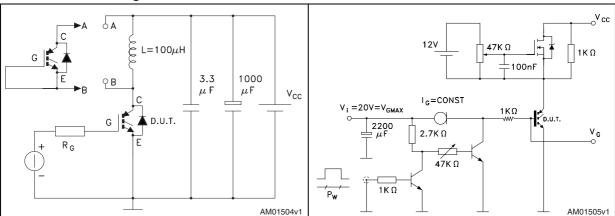
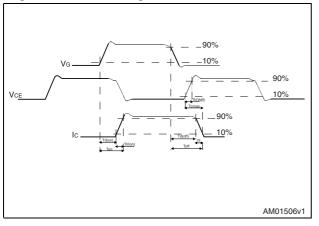


Figure 15. Gate charge test circuit

Figure 16. Switching waveform



57

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S		5.50	

Table 8. TO-247 mechanical data



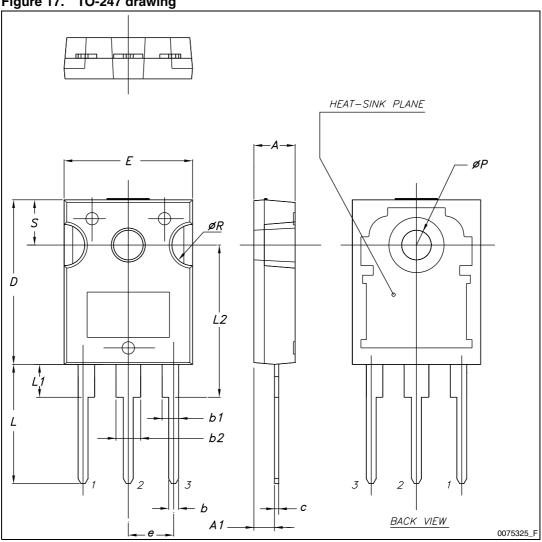


Figure 17. TO-247 drawing



5 Revision history

Table 9.Document revision history

Date	Revision	Changes	
18-Jan-2010	1	Initial release.	
21-Jan-2011	2	Document status promoted from preliminary data to datasheet.	



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